

# Performance Measures

The basics...

- ✦ Momentum resolution
  - ✦ High-momentum limit
  - ✦ Low-momentum limit
- ✦ Track reconstruction efficiency
  - ✦ Prompt tracks
  - ✦ Tracks originating outside
- ✦ Production of secondaries
  - ✦ Tracking confusion
  - ✦ PFA confusion

[http://home.fnal.gov/~marcel/Tracking\\_review.doc](http://home.fnal.gov/~marcel/Tracking_review.doc)

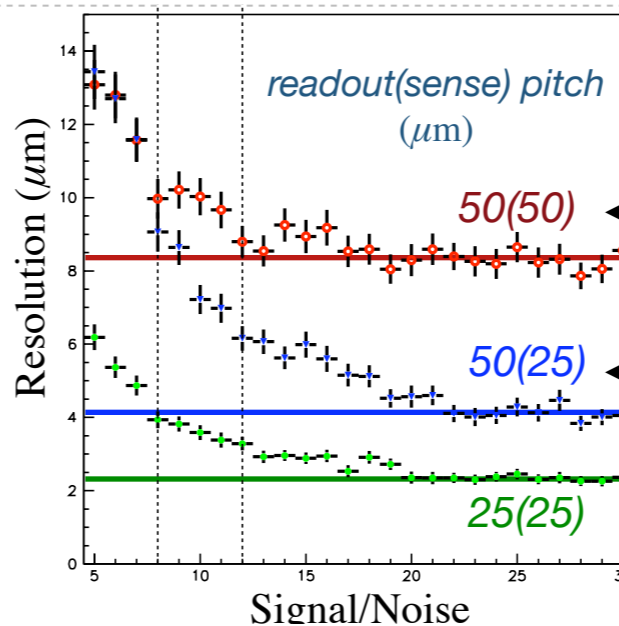


# Performance Measures

- ⬢ Billoir-based calculator (LCDTRK- UCSC)
  - ⬢ high-momentum: single-hit precision
  - ⬢ low-momentum: material

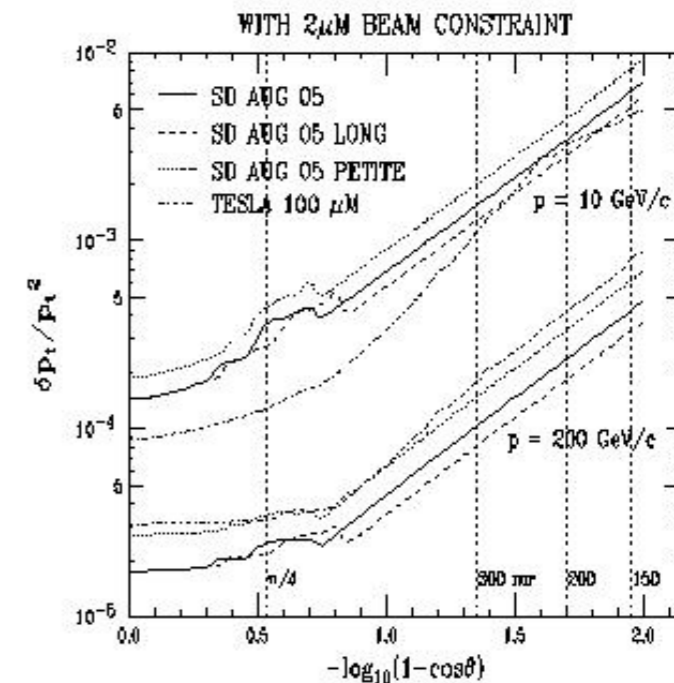
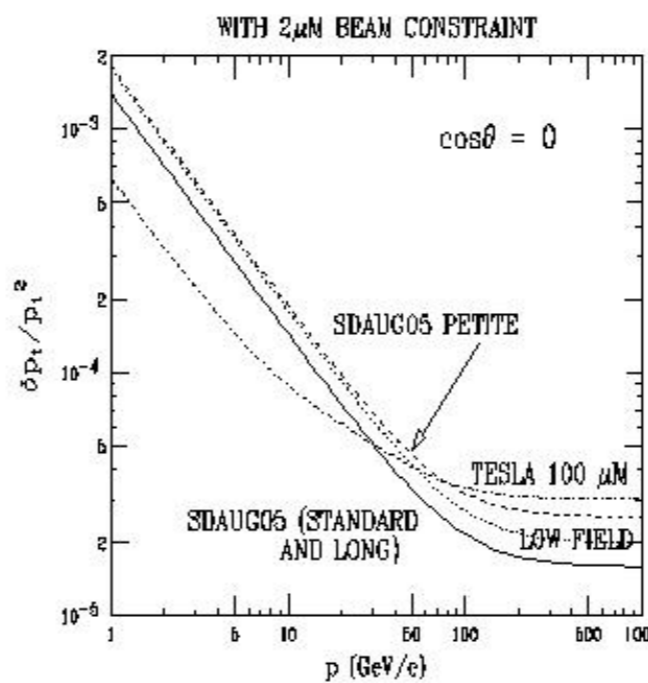
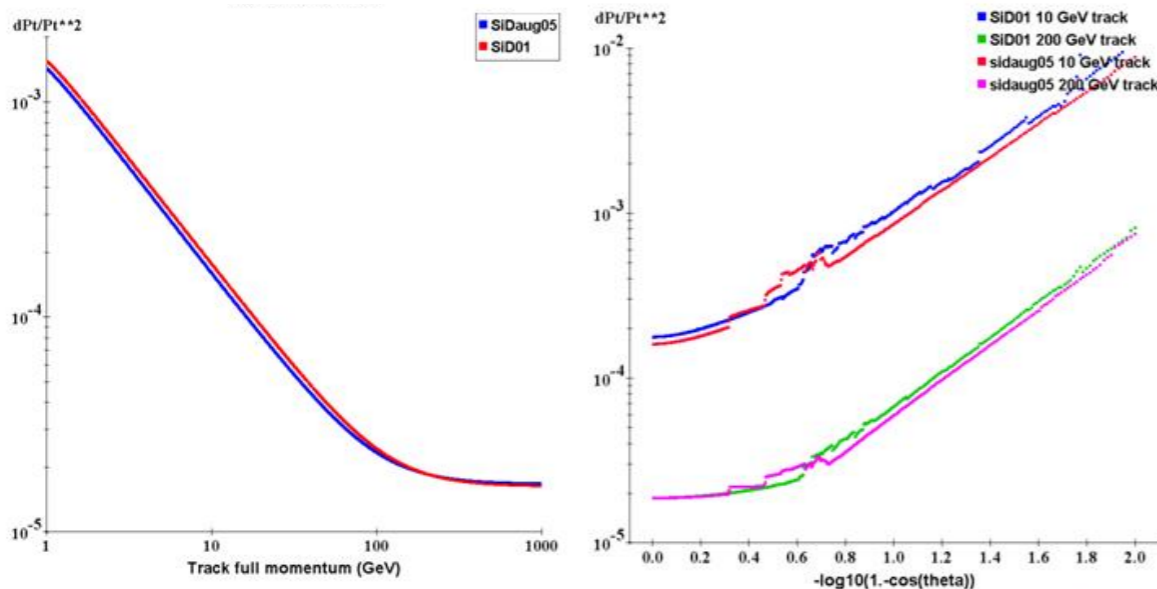
$$\frac{\delta p_t}{p_t^2} = a \oplus \frac{b}{p_t \sin \theta}$$

- ⬢ used for “fast MC” physics studies
- ⬢ Full GEANT MC (weight matrix fitter)



long ladders

short ladders



# Efficiency

## VXD-seeded tracking:

- 95% of all tracks
- 99% of prompt tracks
- Very pure in central, less in forward

## Outer-tracker standalone

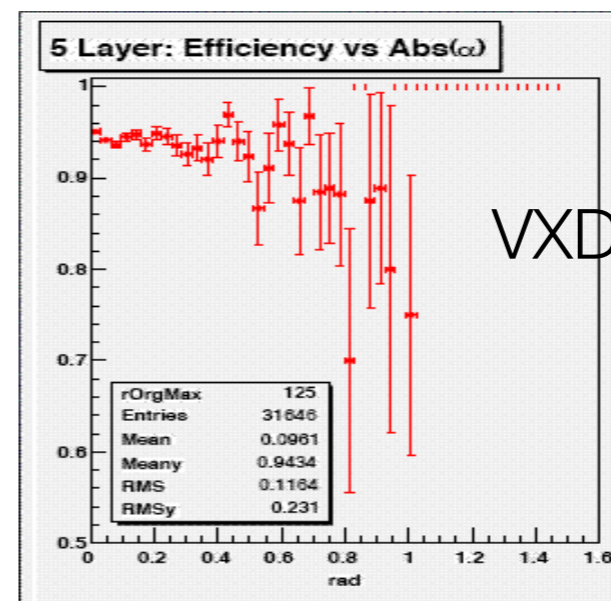
- 99% of prompt tracks
- 50% non-prompt, highly pure
- 25% non-prompt, less-pure

## Calorimeter-seeded tracking

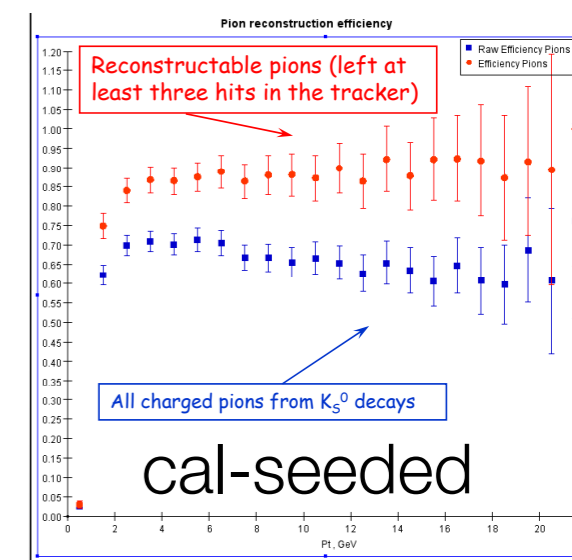
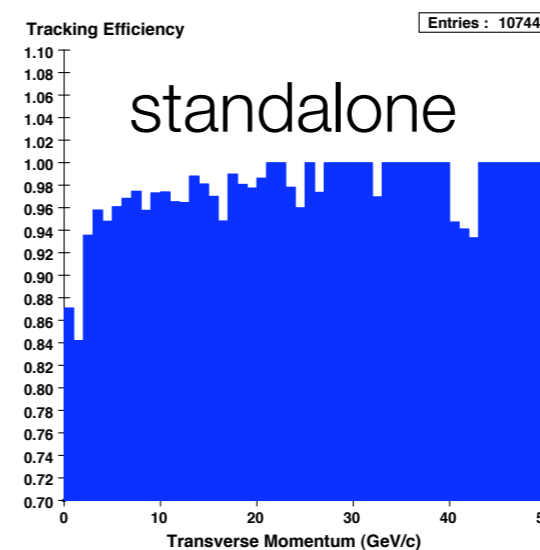
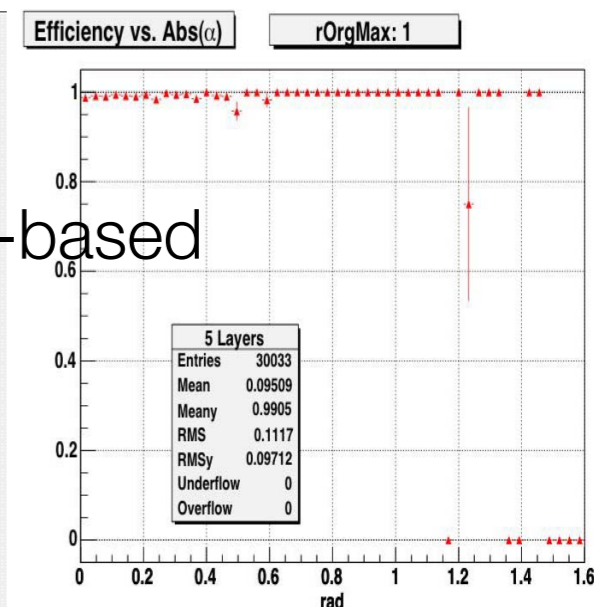
- 90% of non-prompt tracks with 3-hits in tracker

## Room for improvement, combination

studying z-segmentation, tools becoming available for strip simulation



VXD-based



# Optimizations

## momentum resolution

- relatively easy to optimize: pitch, S/N, material
- more difficult to define (and agree upon) the exact requirements

## efficiency

- much more difficult:
  - z-segmentation (starting)
  - stereo? (becoming possible)
  - material
  - # layers
  - S/N
  - backgrounds
  - VXD readout scheme
  - and many, many, more...

# Comparisons

- ❏ For high-pt, silicon cannot be beat
- ❏ At low-pt, goal is to make silicon comparably thin to TPC
- ❏ Efficiency is key. Very difficult to compare
  - ❏ No common framework for TPC, All-silicon reconstruction
  - ❏ Very different algorithms
  - ❏ Very different susceptibility to backgrounds and other subdetectors